# 零件承认书



#### SPECIFICATION FOR APPROVAL

| 客户名称 | : 0110               |
|------|----------------------|
| 增益型与 | :                    |
|      |                      |
| 规格描述 | ZEACM9070F贴片共模滤波器规格书 |
| 日 斯  | : 2023/5/01          |
| 版本   |                      |
|      |                      |

#### 增益签核:

| 制订 | 审核  | 核准  |
|----|-----|-----|
| 张翔 | 刘业明 | 柯文学 |

#### 客户签核:

| 工程 | 审核 | 核准 |
|----|----|----|
|    |    |    |
|    |    |    |
|    |    |    |



#### 东莞市增益实业有限公司

地址: 东莞市塘厦镇林村塘厦大道北552号

电话: 0769-87321000 传真: 0769-87891229

| 物料类型: | 共模电感      |
|-------|-----------|
| 日期:   | 2023/5/01 |
| 版 本:  | A         |
|       |           |

# 111.

### 东莞市增益实业有限公司

### SMD Common Mode Inductor





### 产品特征:

适用大电流的片式共模滤波器 所有系列产品的形状均控制在最小限度

同时共模阻抗超过了300~1000(10MHz时)可大幅抑制共模噪音 产品的高度尺寸也被控制在较低水平

能够适应不断小型轻量化的便携式设备的高密度化趋势

符合RoHS,无卤和REACH

采用紧凑的SMD封装工艺,节省PCB空间

工作温度范围: -55 ~+125

### 产品应用:

数据线、信号线的共模噪声抑制

电源线的共模噪声抑制80VDC(42VAC)

EMI对策用

特别适用于USB、CAN、IEEE194(FireWire)、HDMI、LVDS、 LAN等线路的电磁干扰抑制

#### 产品型号识别:

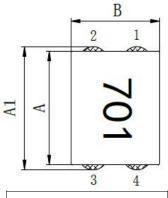
<u>ZEACM 9070F - 301 T6A00</u> 1 <u>2</u> 3 <u>4</u> 1.类型:贴片共模滤波器

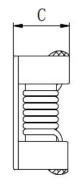
2.规格外形尺寸

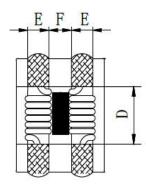
3.阻抗:301=300

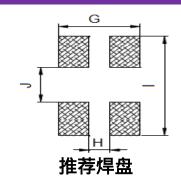
4.T: 编带包装 6A00: 额定电流, 6A

### 产品外形尺寸(单位:mm):



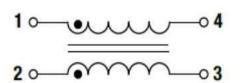






| P/N        | A    | <b>A1</b> | В    | С    | D    | E    | F    | G    | Н    | I     | J    |
|------------|------|-----------|------|------|------|------|------|------|------|-------|------|
|            | ±0.5 | ±0.5      | ±0.5 | Max  | Тур  | Тур  | Тур  | Тур  | Тур  | Тур   | Тур  |
| ZEACM9070F | 9.00 | 9.50      | 7.00 | 4.80 | 5.60 | 1.50 | 1.70 | 5.50 | 1.50 | 10.50 | 5.00 |

#### 产品电路图:





### 产品电气特性(25℃下的电气规格):

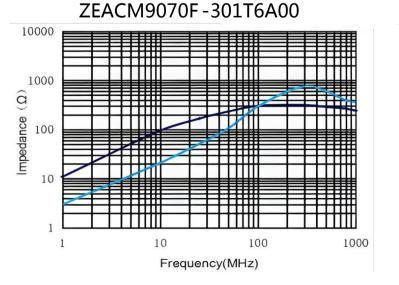
| 规格型号                 |          | 訓抗       | 额定电流        | 直流电阻      | 绝缘电阻    | 额定电压   | 测试频率       | 印字  |
|----------------------|----------|----------|-------------|-----------|---------|--------|------------|-----|
| Part No.             | Z Min(Ω) | Z Typ(Ω) | Max.Ir(A)   | Max. (mΩ) | Min(MΩ) | Max(V) | Test Freq. |     |
| ZEACM9070F -301T6A60 | 225      | 300      | 6.6         | 5.5       | 10M     | 80     | 100MHz     | 301 |
| ZEACM9070F -501T6A00 | 450      | 600      | 6.0         | 7.3       | 10M     | 80     | 100MHz     | 501 |
| ZEACM9070F -601T5A50 | 500      | 700      | <b>5.</b> 5 | 9.0       | 10M     | 80     | 100MHz     | 601 |
| ZEACM9070F -701T5A50 | 500      | 700      | 5.5         | 9.0       | 10M     | 80     | 100MHz     | 701 |
| ZEACM9070F -102T4A40 | 750      | 1000     | 4.4         | 11.8      | 10M     | 80     | 100MHz     | 102 |
| ZEACM9070F -202T3A30 | 1500     | 2200     | 3.3         | 45.5      | 10M     | 80     | 100MHz     | 202 |
| ZEACM9070F -222T3A30 | 1700     | 2200     | 3.3         | 45.5      | 10M     | 80     | 100MHz     | 222 |
| ZEACM9070F -272T2A20 | 2000     | 2700     | 2.2         | 72.8      | 10M     | 80     | 100MHz     | 272 |
| ZEACM9070F -302T2A20 | 2500     | 3000     | 2.2         | 72.8      | 10M     | 80     | 100MHz     | 302 |

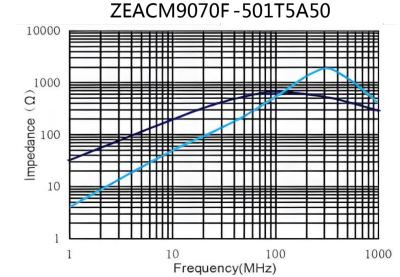
Rated Current: the actual value of DC current when the temperature rise is T 40 (Ta = 25 ).

#### 产品特性曲线图

Common Mode

Differential Mode

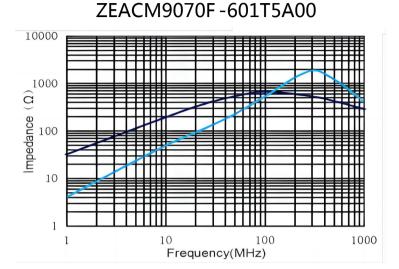




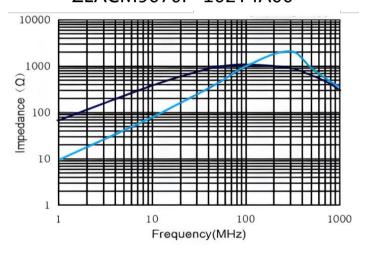


### 产品特性曲线图:

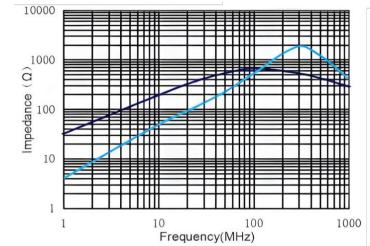
### 山口打工四三人区



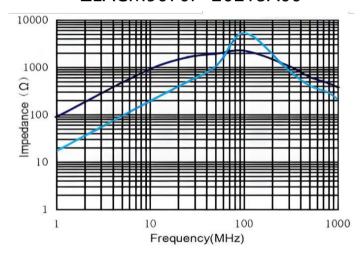




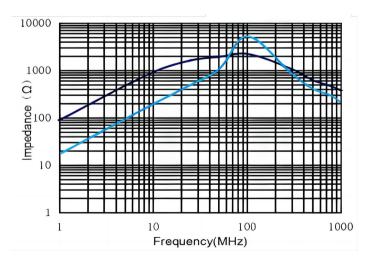
ZEACM9070F -701T5A00



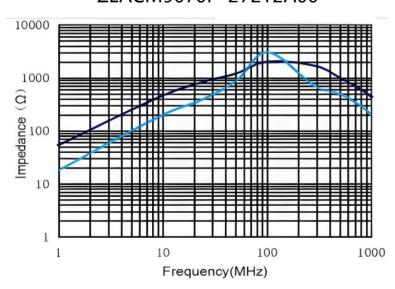
ZEACM9070F-202T3A00



ZEACM9070F-222T3A00



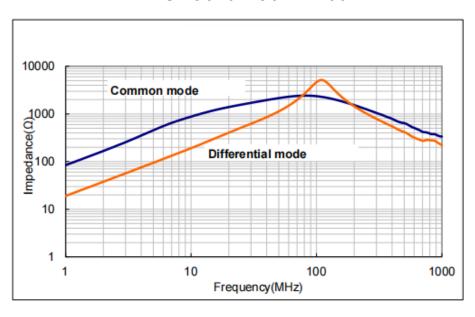
ZEACM9070F-272T2A00





### 产品特性曲线图:

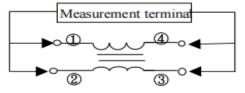
ZEACM9070F-302T2A00



### 产品电气特性测试设备

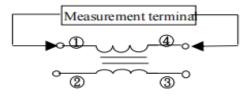
#### Impedance

Measured by using HP4291B RF Impedance Analyzer.



#### DC Resistance

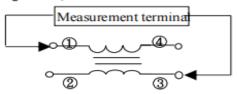
Measured by using Chroma 16502 milliohm meter.



#### Insulation Resistance

Measured by using Chroma 19073

Measurement voltage: 50v, Measurement time: 60 sec.





## 可靠性测试:

| TEST ITEM            | SPECIFICATION                                      | TEST DETAILS   |
|----------------------|--|--|
| Solder ability       | The product shall be connected to the test         | Apply cream solder to the printed circuit board .  |
|                      | circuit board by the fillet (the height is 0.2mm). | Refer to clause 8 for Reflow profile.  |
|                      |  |  |
| Resistance to        | There shall be no damage or problems.              | Temperature profile of reflow soldering  |
| Soldering heat       |  | © 300 — soldering (Peak temperature 260±3°C 10 sec)  |
| (reflow soldering)   |  | (Peak temperature 260±3°C 10 sec)  Pre-heating  150  200  Pre-heating  150 - 180°C  Slow cooling (Stored at room temperature)  The specimen shall be passed through the reflow oven  with the condition shown in the above profile for 1 time. |
|                      |  | The specimen shall be stored at standard atmospheric   |
|                      |  | eric conditions for 1 hour, after which the measurement  |
|                      |  | shall be made.   |
| Terminal strength    | The terminal electrode and the ferrite must        | Solder a chip to test substrate , and then laterally apply   |
|                      | not damaged.                                       | a load 9.8N in the arrow direction.  |
|                      |  | Printed circuit board  |
| Strength on PC board | The terminal electrode and the ferrite must        | Solder a chip to test substrate and then apply a load.   |
| bending              | not damaged.                                       | Test board:FR4 100×40×1mm  R10 Fall speed:1mm/sec.  Dimensions in mm   |
| High                 | Impedance:Within±20% of the initial value.         | After the samples shall be soldered onto the test circuit  |
| temperature          | Insulation resistance and DC resistance on the     | board,the test shall be done.  |
| resistance           | specification(refer to clause 2-1) shall be met.   | Measurement : After placing for 24 hours min.  |
|                      | The terminal electrode and the ferrite must not    | Temperature: +125±2℃   |
|                      | damaged.   | Applied voltage : Rated voltage  |
|                      |  | Applied current : Rated current  |
|                      |  | Testing time: 500±12 hours   |
|                      |  |  |



## 可靠性测试:

| TEST ITEM     | SPECIFICATION   | TEST DETAILS   |
|---------------|---|--|
| Humidity      | Impedance:Within±20% of the initial value.  | After the samples shall be soldered onto the test circuit  |
| resistance    | Insulation resistance and DC resistance on the  | board,the test shall be done.  |
|               | specification(refer to clause 2-1) shall be met.  | Measurement : After placing for 24 hours min.  |
|               | The terminal electrode and the ferrite must not   | Temperature : +60±2℃ , Humidity : 90 to 95 %RH   |
|               | damaged.  | Applied voltage : Rated voltage  |
|               |   | Applied current : Rated current  |
|               |   | Testing time : 500±12 hours  |
| Thermal shock | Impedance:Within±20% of the initial value. Insulation resistance and DC resistance on the specification(refer to clause 2-1) shall be met. The terminal electrode and the ferrite must not damaged. | 1 cycle<br>30 min.<br>30 sec<br>30 min.  |
| Low           | Impedance:Within±20% of the initial value.  | After the samples shall be soldered onto the test  |
| temperature   | Insulation resistance and DC resistance on the  | circuit board,the test shall be done.  |
| storage       | specification(refer to clause 2-1) shall be met.  | Measurement : After placing for 24 hours min.  |
|               | The terminal electrode and the ferrite must   | Temperature : -40±2℃   |
|               | not damaged.  | Testing time : 500±12 hours  |
| Vibration     | Impedance:Within±20% of the initial value.  | After the samples shall be soldered onto the test circuit  |
|               | Insulation resistance and DC resistance on  | board,the test shall be done.  |
|               | the specification(refer to clause 2-1)  | Frequency : 10 to 55 Hz  |
|               | shall be met.   | Amplitude : 1.52 mm  |
|               | The terminal electrode and the ferrite must   | Dimension and times : X ,Y and Z directions  |
|               | not damaged.  | for 2 hours each.  |
| Solderability | New solder More than 75%  | Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall |
|               |   | then be preheated for about 2 minutes in a temperature   |
|               |   | of 130~150℃ and after it has been immersed to a depth  |
|               |   | 0.5mm below for 3±0.2 seconds fully in molten solder   |
|               |   |  |
|               |   | M705 with a temperature of 245±2°C. More than 75% of the   |
|               |   | electrode sections shall be couered  |
|               |   | with new solder smoothly when the sample is taken out  |
|               |   | of the solder bath.  |